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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Attn: **ISSUE BRANCH**
Hiroaki INOUE et al. : **Confirmation No. 3064**
Serial No. 09/890,455 : [Group Art Unit 2812
Filed March 12, 2002 : Examiner Lynne A. Gurley]

ELECTROLESS PLATING LIQUID AND METHOD
OF FORMING INTERCONNECTION USING SUCH
AN ELECTROLESS PLATING LIQUID

SUBMISSION OF REVISED FORMAL DRAWINGS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

There are submitted herewith three sheets of bristol board formal drawings in the above-identified application showing Figures 1-3.

The attached drawings have been revised to correct each item objected to by the Examiner and/or the Chief Draftsman.

Kindly substitute the attached formal drawings for those of record.

Respectfully submitted,

Hiroaki INOUE et al.

By Warren M. Cheek, Jr.

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